

74ALVCH16821

20-bit bus-interface D-type flip-flop; positive-edge trigger;
3-state

Rev. 3 — 2 February 2018

Product data sheet

1 General description

The 74ALVCH16821 has two 10-bit, edge triggered registers, with each register coupled to a 3-state output buffer. The two sections of each register are controlled independently by the clock (nCP) and output enable (nOE) control gates.

Each register is fully edge triggered. The state of each nDn input, one set-up time before the Low-to-High clock transition, is transferred to the corresponding flip-flop's nQn output.

When nOE is LOW, the data in the register appears at the outputs. When nOE is HIGH, the outputs are in high impedance OFF state. Operation of the nOE input does not affect the state of the flip-flops.

The 74ALVCH16821 has active bus hold circuitry which is provided to hold unused or floating data inputs at a valid logic level. This feature eliminates the need for external pull-up or pull-down resistors.

2 Features and benefits

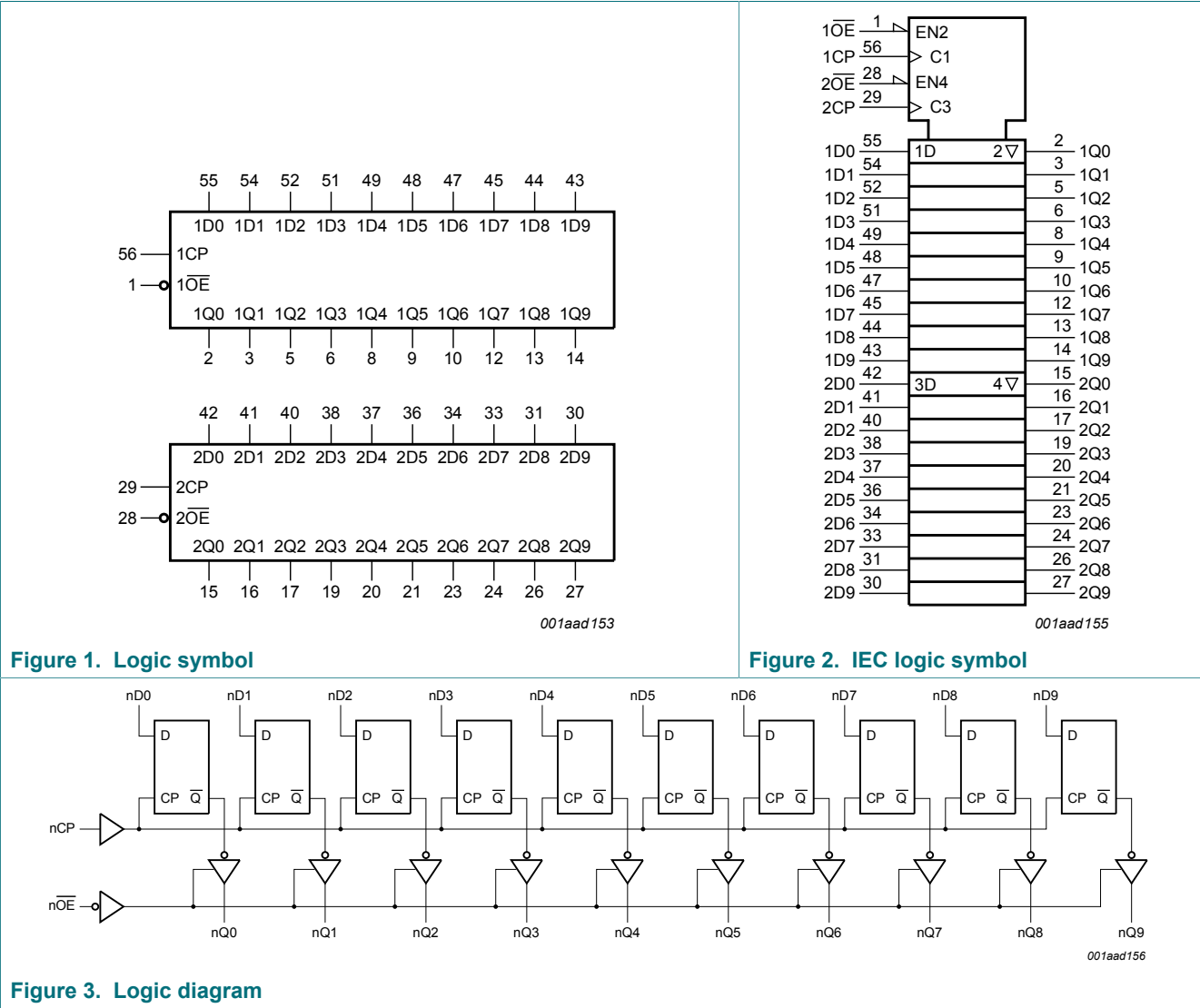
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low-power consumption
- Direct interface with TTL levels
- Current drive ± 24 mA at 3.0 V
- MULTIBYTE flow-through standard pin-out architecture
- Low inductance multiple V_{CC} and GND pins for minimum noise and ground bounce
- Output drive capability 50 Ω transmission lines at 85°C
- All data inputs have bushold
- Complies with JEDEC standard no. 8-1A
- Complies with JEDEC standards:
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM ANSI/ESDA/JEDEC JS-001 exceeds 2000 V
 - CDM JESD22-C101E exceeds 1000 V

3 Ordering information

Table 1. Ordering information

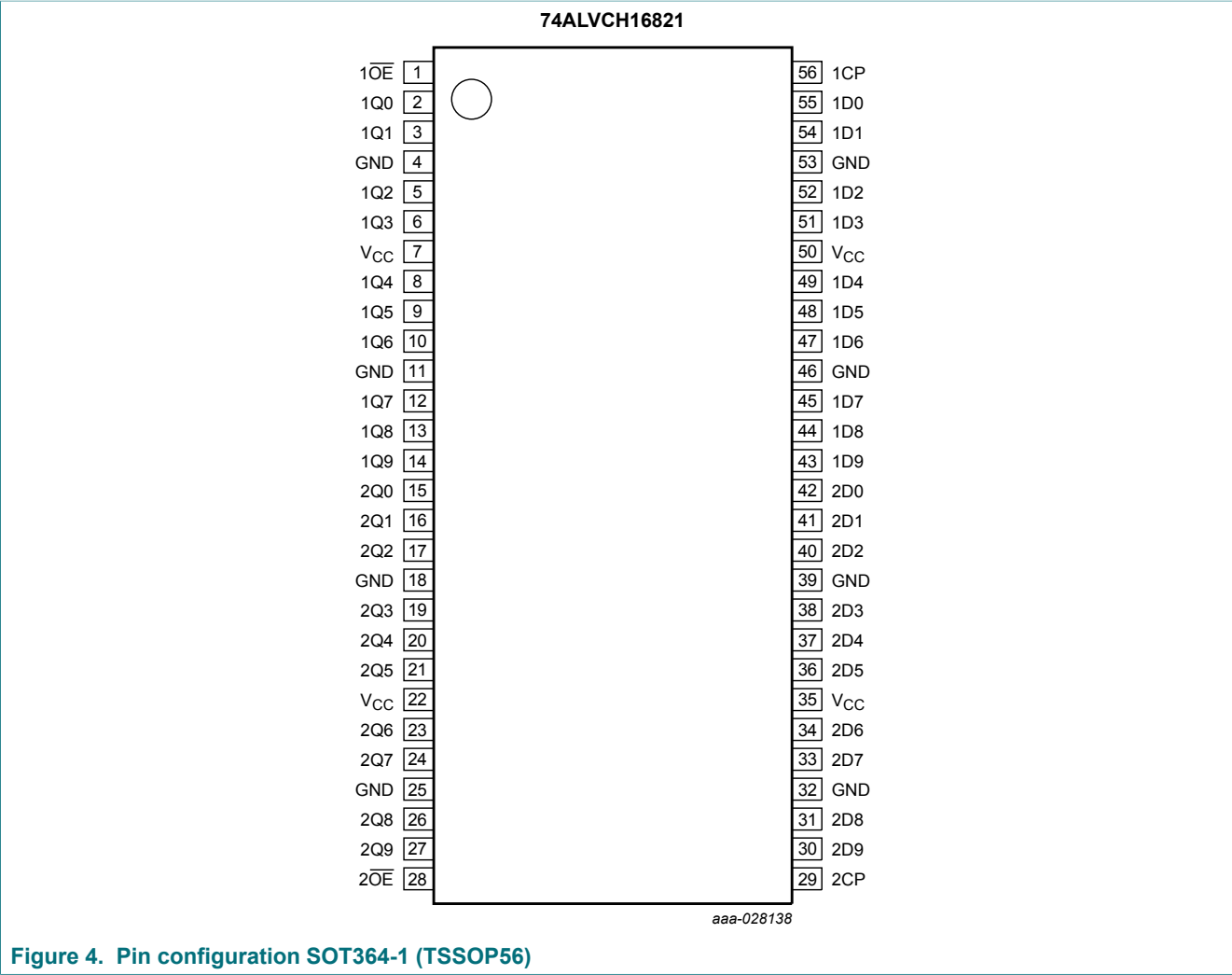
| Type number | Package | | | |
|-----------------|-------------------|---------|--|----------|
| | Temperature range | Name | Description | Version |
| 74ALVCH16821DGG | –40 °C to +85 °C | TSSOP56 | plastic thin shrink small outline package; 56 leads; body width 6.1 mm | SOT364-1 |

4 Functional diagram



5 Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|---|--|---|
| 1D0, 1D1, 1D2, 1D3, 1D4, 1D5, 1D6, 1D7, 1D8, 1D9 | 55, 54, 52, 51, 49, 48, 47, 45, 44, 43 | data inputs |
| 2D0, 2D1, 2D2, 2D3, 2D4, 2D5, 2D6, 2D7, 2D8, 2D9 | 42, 41, 40, 38, 37, 36, 34, 33, 31, 30 | data inputs |
| 1Q0, 1Q1, 1Q2, 1Q3, 1Q4, 1Q5, 1Q6, 1Q7, 1Q8, 1Q9 | 2, 3, 5, 6, 8, 9, 10, 12, 13, 14 | data outputs |
| 2Q0, 2Q1, 2Q2, 2Q3, 2Q4, 2Q5, 2Q6, 2Q7, 2Q8, 2Q9 | 15, 16, 17, 19, 20, 21, 23, 24, 26, 27 | data outputs |
| 1 \overline{OE} , 2 \overline{OE} | 1, 28 | output enable inputs (active LOW) |
| 1CP, 2CP | 56, 29 | clock pulse inputs (active rising edge) |
| GND | 4, 11, 18, 25, 32, 39, 46, 53 | ground (0 V) |
| V _{CC} | 7, 22, 35, 50 | supply voltage |

6 Functional description

Table 3. Function table ^[1]

| Operating mode | Input | | | Internal register | Output |
|------------------------|-------------------|-----|-----|-------------------|--------|
| | n \overline{OE} | nCP | nDn | | nQn |
| Load and read register | L | ↑ | l | L | L |
| | L | ↑ | h | H | H |
| Hold | L | NC | X | NC | NC |
| Disable outputs | H | NC | X | NC | Z |
| | H | ↑ | nDn | nDn | Z |

- [1] H = HIGH voltage level;
 h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition;
 L = LOW voltage level;
 l = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition;
 NC = no change;
 X = don't care;
 Z = high-impedance OFF-state;
 ↑ = LOW-to-HIGH clock transition.

7 Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|----------------------|-------------------------------|--|------|----------------|------|
| V_{CC} | supply voltage | | -0.5 | +4.6 | V |
| V_I | input voltage | For control pins ^[1] | -0.5 | +4.6 | V |
| | | For data inputs ^[1] | -0.5 | $V_{CC} + 0.5$ | V |
| V_O | output voltage | ^[1] | -0.5 | $V_{CC} + 0.5$ | V |
| I_{IK} | input clamping current | $V_I < 0$ V | -50 | - | mA |
| I_{OK} | output clamping current | $V_O > V_{CC}$ or $V_O < 0$ V | - | ±50 | mA |
| $I_{O(sink/source)}$ | output sink or source current | $V_O = 0$ V to V_{CC} | - | ±50 | mA |
| I_{CC} | supply current | | - | 100 | mA |
| I_{GND} | ground current | | -100 | - | mA |
| T_{stg} | storage temperature | | -65 | +150 | °C |
| P_{tot} | total power dissipation | $T_{amb} = -40$ °C to +125 °C ^[2] | - | 600 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] Above 55 °C the value of P_{tot} derates linearly with 8 mW/K.

8 Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------|-------------------------------------|--|-----|----------|------|
| V_{CC} | supply voltage | 2.5 V range for maximum speed performance at 30 pF output load | 2.3 | 2.7 | V |
| | | 3.3 V range for maximum speed performance at 50 pF output load | 3.0 | 3.6 | V |
| V_I | input voltage | | 0 | V_{CC} | V |
| V_O | output voltage | | 0 | V_{CC} | V |
| T_{amb} | ambient temperature | in free air | -40 | +85 | °C |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 2.3$ V to 3.0 V | - | 20 | ns/V |
| | | $V_{CC} = 3.0$ V to 3.6 V | - | 10 | ns/V |

9 Static characteristics

Table 6. Static characteristics

At recommended operating conditions; $T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ ^[1] | Max | Unit |
|-----------------|---------------------------------|--|----------------|--------------------|------|---------------|
| V_{IH} | HIGH-level input voltage | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.7 | 1.2 | - | V |
| | | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$ | 2.0 | 1.5 | - | V |
| V_{IL} | LOW-level input voltage | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | - | 1.2 | 0.7 | V |
| | | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$ | - | 1.5 | 0.8 | V |
| V_{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = -100\text{ }\mu\text{A}$; $V_{CC} = 2.3\text{ V to }3.6\text{ V}$ | $V_{CC} - 0.2$ | V_{CC} | - | V |
| | | $I_O = -6\text{ mA}$; $V_{CC} = 2.3\text{ V}$ | $V_{CC} - 0.3$ | $V_{CC} - 0.08$ | - | V |
| | | $I_O = -12\text{ mA}$; $V_{CC} = 2.3\text{ V}$ | $V_{CC} - 0.6$ | $V_{CC} - 0.26$ | - | V |
| | | $I_O = -12\text{ mA}$; $V_{CC} = 2.7\text{ V}$ | $V_{CC} - 0.5$ | $V_{CC} - 0.14$ | - | V |
| | | $I_O = -12\text{ mA}$; $V_{CC} = 3.0\text{ V}$ | $V_{CC} - 0.6$ | $V_{CC} - 0.09$ | - | V |
| | | $I_O = -24\text{ mA}$; $V_{CC} = 3.0\text{ V}$ | $V_{CC} - 1.0$ | $V_{CC} - 0.28$ | - | V |
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = 100\text{ }\mu\text{A}$; $V_{CC} = 2.3\text{ V to }3.6\text{ V}$ | - | GND | 0.20 | V |
| | | $I_O = 6\text{ mA}$; $V_{CC} = 2.3\text{ V}$ | - | 0.07 | 0.40 | V |
| | | $I_O = 12\text{ mA}$; $V_{CC} = 2.3\text{ V}$ | - | 0.15 | 0.70 | V |
| | | $I_O = 12\text{ mA}$; $V_{CC} = 2.7\text{ V}$ | - | 0.14 | 0.40 | V |
| | | $I_O = 24\text{ mA}$; $V_{CC} = 3.0\text{ V}$ | - | 0.27 | 0.55 | V |
| I_I | input leakage current | $V_{CC} = 2.3\text{ V to }3.6\text{ V}$; $V_I = V_{CC}$ or GND | - | 0.1 | 5 | μA |
| I_{OZ} | OFF-state output current | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$; $V_I = V_{IH}$ or V_{IL} ; $V_O = V_{CC}$ or GND | - | 0.1 | 10 | μA |
| I_{CC} | supply current | $V_{CC} = 2.3\text{ V to }3.6\text{ V}$; $V_I = V_{CC}$ or GND; $I_O = 0\text{ A}$ | - | 0.2 | 40 | μA |
| ΔI_{CC} | additional supply current | $V_{CC} = 2.3\text{ V to }3.6\text{ V}$; $V_I = V_{CC} - 0.6\text{ V}$; $I_O = 0\text{ A}$ | - | 150 | 750 | μA |
| I_{BHL} | bus hold LOW current | $V_{CC} = 2.3\text{ V}$; $V_I = 0.7\text{ V}$ | 45 | - | - | μA |
| | | $V_{CC} = 3.0\text{ V}$; $V_I = 0.8\text{ V}$ | 75 | 150 | - | μA |
| I_{BHH} | bus hold HIGH current | $V_{CC} = 2.3\text{ V}$; $V_I = 1.7\text{ V}$ | -45 | - | - | μA |
| | | $V_{CC} = 3.0\text{ V}$; $V_I = 2.0\text{ V}$ | -75 | -175 | - | μA |
| I_{BHLO} | bus hold LOW overdrive current | per data input; $V_{CC} = 3.6\text{ V}$ | 500 | - | - | μA |
| I_{BHHO} | bus hold HIGH overdrive current | per data input; $V_{CC} = 3.6\text{ V}$ | -500 | - | - | μA |
| C_I | input capacitance | | - | 5.0 | - | pF |

[1] All typical values are measured at $T_{amb} = 25\text{ }^{\circ}\text{C}$.

10 Dynamic characteristics

Table 7. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 8](#)

| Symbol | Parameter | Conditions | Min | Typ ^[1] | Max | Unit |
|-----------|-------------------------------|---|-----|--------------------|-----|------|
| t_{pd} | propagation delay | nCP to nQn; see Figure 5 ^[2] | | | | |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 1.0 | 2.6 | 5.8 | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | 1.0 | 2.8 | 5.3 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 1.0 | 2.5 | 4.5 | ns |
| t_{en} | enable time | nOE to nQn; see Figure 7 ^[2] | | | | |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 1.0 | 2.8 | 6.6 | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | 1.0 | 3.2 | 6.2 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 1.0 | 2.3 | 5.1 | ns |
| t_{dis} | disable time | nOE to nQn; see Figure 7 ^[2] | | | | |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 1.0 | 2.2 | 5.7 | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | 1.0 | 3.1 | 5.0 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 1.0 | 2.8 | 4.6 | ns |
| t_{su} | set-up time | nDn to nCP; see Figure 6 | | | | |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 1.4 | 0.3 | - | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | 1.2 | 0.3 | - | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 1.0 | 0.2 | - | ns |
| t_h | hold time | nDn to nCP; see Figure 6 | | | | |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 0.4 | 0.0 | - | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | 0.6 | -0.3 | - | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 0.8 | 0.4 | - | ns |
| t_w | pulse width | nCP HIGH or LOW; see Figure 5 | | | | |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 3.0 | 1.8 | - | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | 3.3 | 1.7 | - | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 3.3 | 0.2 | - | ns |
| f_{max} | maximum frequency | nCP; see Figure 5 | | | | |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 150 | 250 | - | MHz |
| | | $V_{CC} = 2.7 \text{ V}$ | 150 | 300 | - | MHz |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 150 | 350 | - | MHz |
| C_{PD} | power dissipation capacitance | per latch; $V_I = \text{GND to } V_{CC}$ ^[3] | | | | |
| | | outputs enabled | - | 33 | - | pF |
| | | outputs disabled | - | 17 | - | pF |

[1] Typical values are measured at $T_{amb} = 25^\circ\text{C}$

Typical values for $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ are measured at $V_{CC} = 2.5 \text{ V}$. Typical values for $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ are measured at $V_{CC} = 3.3 \text{ V}$.

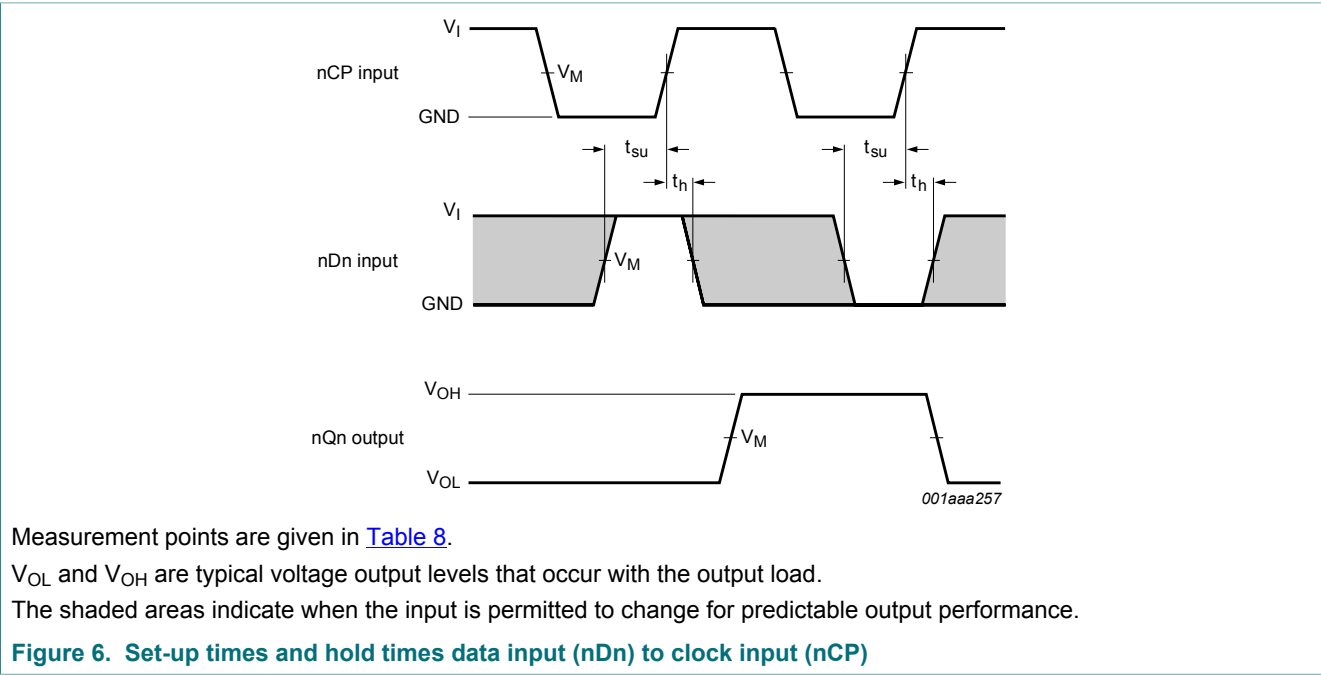
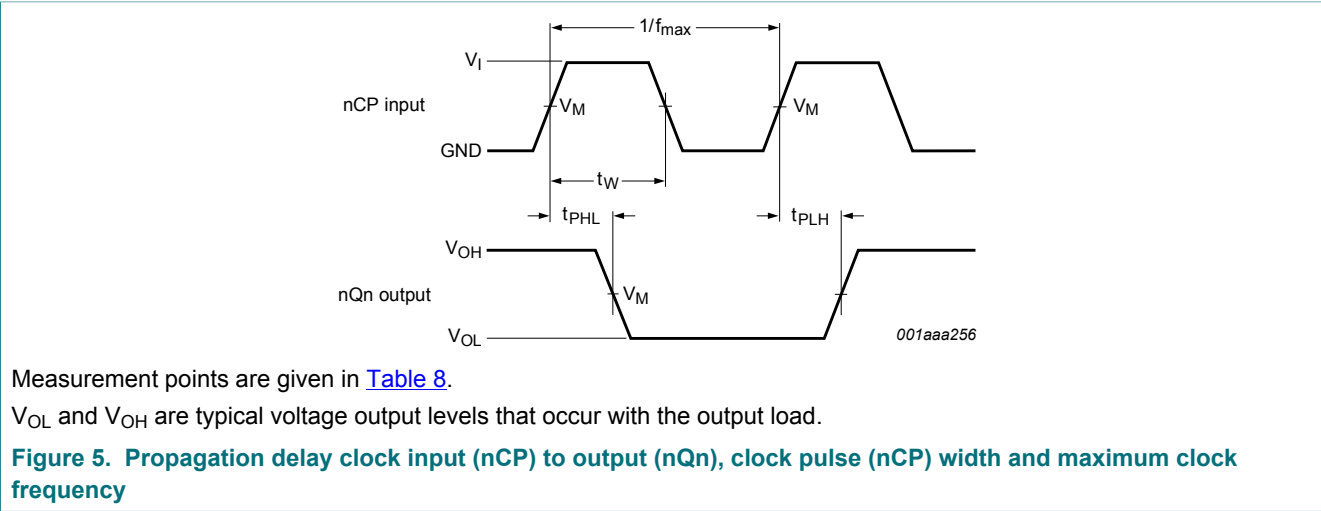
[2] t_{pd} is the same as t_{PLH} and t_{PHL} ; t_{en} is the same as t_{PZL} and t_{PZH} ; t_{dis} is the same as t_{PLZ} and t_{PHZ} .

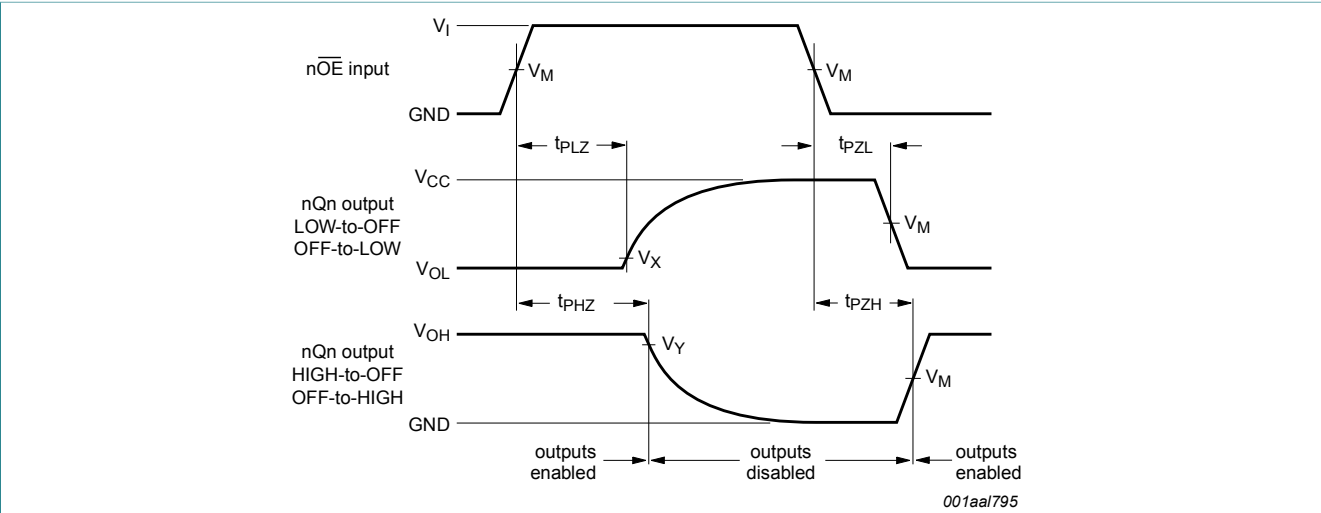
[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW). $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

f_i = input frequency in MHz; f_o = output frequency in MHz; C_L = output load capacitance in pF;

V_{CC} = supply voltage in Volts; N = total load switching outputs; $\sum (C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

10.1 Waveforms and test circuit





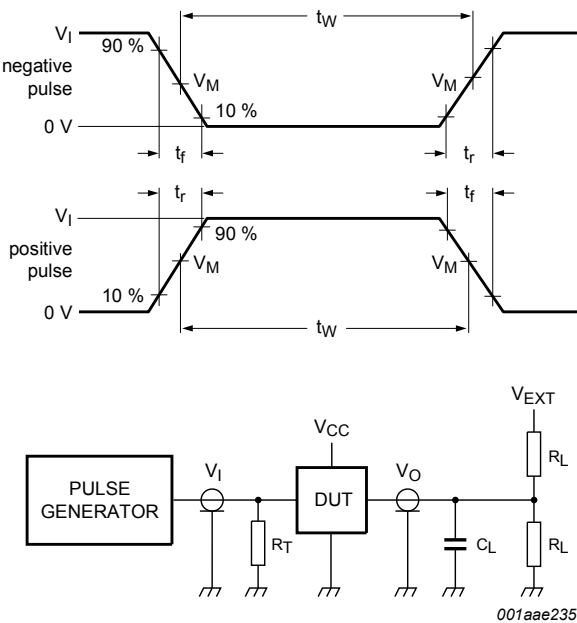
Measurement points are given in [Table 8](#).

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Figure 7. OFF-state to HIGH and LOW propagation delays and LOW and HIGH to OFF-state propagation delays

Table 8. Measurement points

| V_{CC} | Input | | Output | | |
|---------------------|----------------|---------------------|---------------------|--------------------------|--------------------------|
| | V_I | V_M | V_M | V_X | V_Y |
| $< 2.7\text{ V}$ | V_{CC} | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ | $V_{OL} + 0.15\text{ V}$ | $V_{OH} - 0.15\text{ V}$ |
| $\geq 2.7\text{ V}$ | 2.7 V | 1.5 V | 1.5 V | $V_{OL} + 0.3\text{ V}$ | $V_{OH} - 0.3\text{ V}$ |



Test data is given in [Table 9](#).
Definitions test circuit:
 R_L = Load resistance;
 C_L = Load capacitance including jig and probe capacitance;
 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator;
 V_{EXT} = External voltage for measuring switching times.

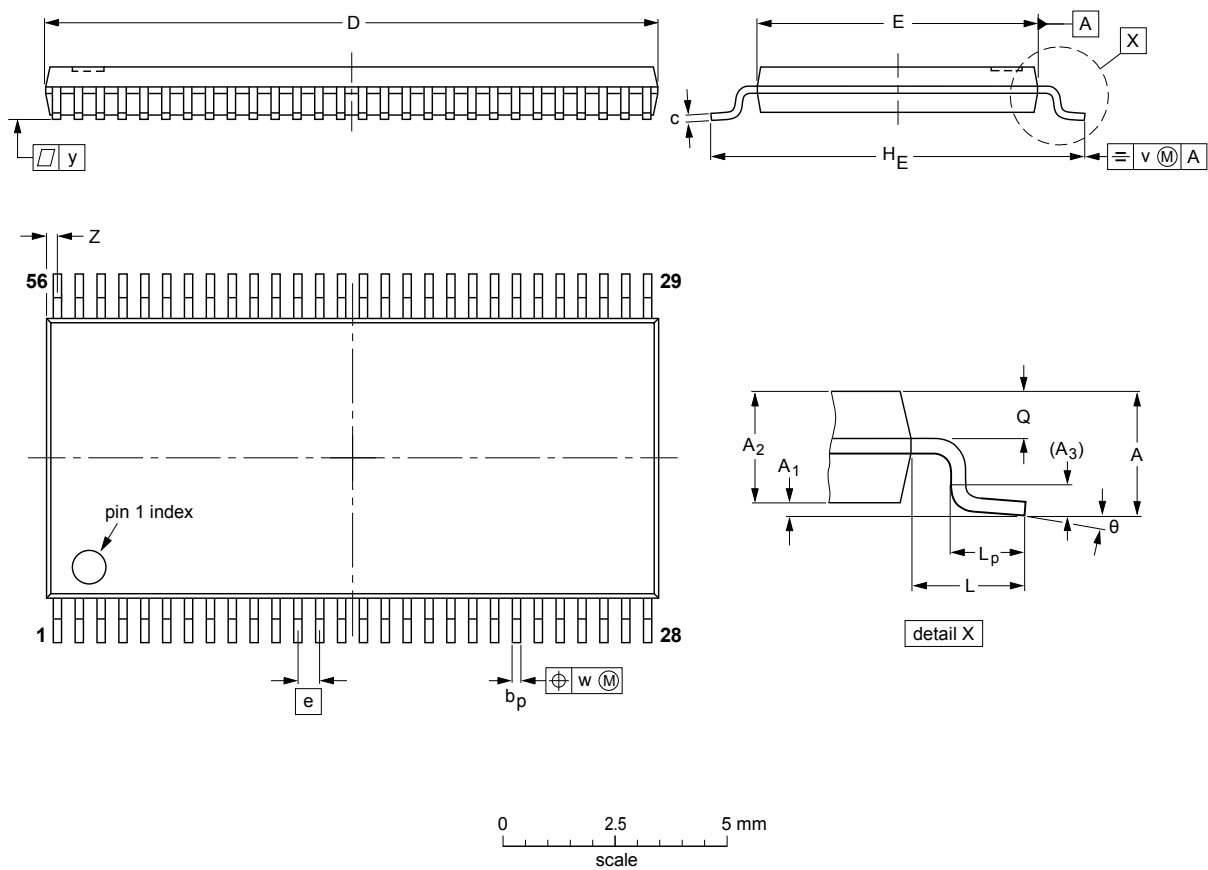
Figure 8. Test circuit for measuring switching times

Table 9. Test data

| Input | | | Load | | V_{EXT} | | |
|--------------|----------|---------------|--------------|-------|--------------------|--------------------|--------------------|
| V_{CC} | V_I | t_r, t_f | R_L | C_L | t_{PHZ}, t_{PZH} | t_{PLZ}, t_{PZL} | t_{PLH}, t_{PHL} |
| < 2.7 V | V_{CC} | ≤ 2.0 ns | 500 Ω | 30 pF | GND | $2 \times V_{CC}$ | open |
| ≥ 2.7 V | 2.7 V | ≤ 2.5 ns | 500 Ω | 50 pF | GND | $2 \times V_{CC}$ | open |

11 Package outline

TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1 mm SOT364-1



DIMENSIONS (mm are the original dimensions).

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽²⁾ | e | H _E | L | L _p | Q | v | w | y | Z | θ |
|------|-----------|----------------|----------------|----------------|----------------|------------|------------------|------------------|-----|----------------|---|----------------|--------------|------|------|-----|------------|----------|
| mm | 1.2 | 0.15 0.05 | 1.05 0.85 | 0.25 | 0.28 0.17 | 0.2 0.1 | 14.1 13.9 | 6.2 6.0 | 0.5 | 8.3 7.9 | 1 | 0.8 0.4 | 0.50 0.35 | 0.25 | 0.08 | 0.1 | 0.5 0.1 | 8° 0° |

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|--------------------|------------|--------|-------|--|------------------------|----------------------|
| | IEC | JEDEC | JEITA | | | |
| SOT364-1 | | MO-153 | | | | 99-12-27 03-02-19 |

Figure 9. Package outline SOT364-1 (TSSOP56)

12 Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|---|
| CMOS | Complementary Metal-Oxide Semiconductor |
| DUT | Device Under Test |
| TTL | Transistor-Transistor Logic |

13 Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|------------------|---|-----------------------|---------------|------------------|
| 74ALVCH16821 v.3 | 20180202 | Product data sheet | - | 74ALVCH16821 v.2 |
| Modifications: | <ul style="list-style-type: none">The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.Legal texts have been adapted to the new company name where appropriate.Type number 74ALVCH16821DL (SOT371-1 / SSOP56) removed | | | |
| 74ALVCH16821 v.2 | 19980529 | Product specification | - | 74ALVCH16821 v.1 |
| 74ALVCH16821 v.1 | 19980529 | Product specification | - | - |

14 Legal information

14.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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Contents

1 General description 1

2 Features and benefits1

3 Ordering information 1

4 Functional diagram2

5 Pinning information 3

5.1 Pinning 3

5.2 Pin description 4

6 Functional description4

7 Limiting values 5

8 Recommended operating conditions 5

9 Static characteristics 6

10 Dynamic characteristics7

10.1 Waveforms and test circuit 8

11 Package outline11

12 Abbreviations 12

13 Revision history 12

14 Legal information 13

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